



SOT1202-2

X2SON6, plastic super thin small outline package; no leads; 6 terminals; 1.0 mm x 1.0 mm x 0.32 mm body

27 March 2018

Package information

1. Package summary

Terminal position code	D (double)
Package type descriptive code	X2SON6
Package type industry code	X2SON6
Package style descriptive code	XSON (extremely thin small outline; no leads)
Package body material type	P (plastic)
Mounting method type	S (surface mount)
Issue date	8-3-2018
Manufacturer package code	SOT1202-2

Table 1. Package summary

Symbol	Parameter	Min	Typ	Nom	Max	Unit
D	package length	0.95	-	1	1.05	mm
E	package width	0.95	-	1	1.05	mm
A	seated height	0.3	-	0.32	0.33	mm
e	nominal pitch	-	-	0.35	-	mm
n ₂	actual quantity of termination	-	-	6	-	A/A



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2. Package outline

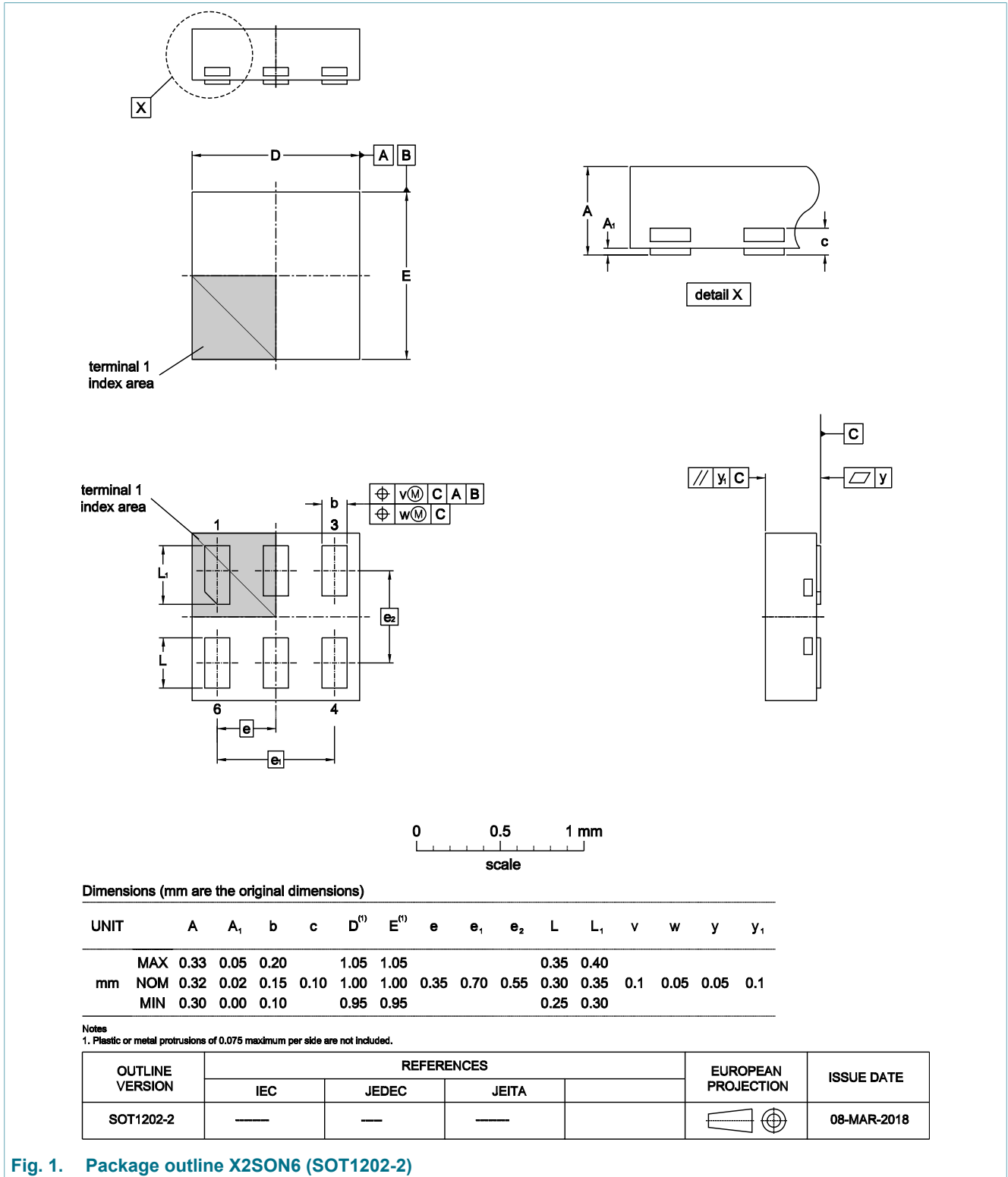


Fig. 1. Package outline X2SON6 (SOT1202-2)

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3. Legal information

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